

## **SGA-6286(Z)**

# DC to 5500 MHz, CASCADABLE SiGe HBT MMIC AMPLIFIER

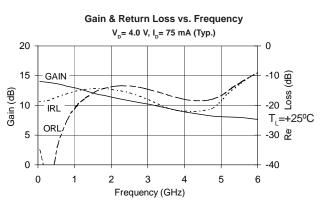
RFMD Green, RoHS Compliant, Pb-Free (Z Part Number)
Package: SOT-86



### **Product Description**

The SGA-6286 is a high performance SiGe HBT MMIC Amplifier. A Darlington configuration featuring one-micron emitters provides high  $F_T$  and excellent thermal performance. The heterojunction increases breakdown voltage and minimizes leakage current between junctions. Cancellation of emitter junction non-linearities results in higher suppression of intermodulation products. Only two DC-blocking capacitors, a bias resistor, and an optional RF choke are required for operation.





#### **Features**

- Broadband Operation: DC to 5500 MHz
- Cascadable 50Ω
- Operates from Single Supply
- Low Thermal Resistance Package

### **Applications**

- PA Driver Amplifier
- Cellular, PCS, GSM, UMTS
- IF Amplifier
- Wireless Data, Satellite

Parameter	Specification			Unit	Condition	
rarameter	Min.	Тур.	Max.	UIIIL	Condition	
Small Signal Gain	12.5	13.6	15.2	dB	850MHz	
		12.4		dB	1950MHz	
		11.2		dB	2400MHz	
Output Power at 1dB Compression		18.7		dBm	850MHz	
		17.8		dBm	1950MHz	
Output Third Intercept Point		35.0		dBm	850MHz	
		33.0		dBm	1950MHz	
Bandwidth Determined by Return Loss		5500		MHz	>10dB	
Input Return Loss		14.6		dB	1950MHz	
Output Return Loss		13.9		dB	1950MHz	
Noise Figure		4.2		dB	1950MHz	
Device Operating Voltage	3.6	4.0	4.4	V		
Device Operating Current	67	75	83	mA		
Thermal Resistance (Junction - Lead)		97		°C/W		

Test Conditions:  $V_S = 8V$ ,  $I_D = 75$  mA Typ., OIP<sub>3</sub> Tone Spacing=1MHz,  $P_{OLIT}$  per tone=0dBm,  $R_{BIAS} = 51\Omega$ ,  $T_L = 25$  °C,  $Z_S = Z_L = 50\Omega$ 



#### **Absolute Maximum Ratings**

Parameter	Rating	Unit
Max Device Current (I <sub>D</sub> )	150	mA
Max Device Voltage (V <sub>D</sub> )	6	V
Max RF Input Power	+18	dBm
Max Junction Temp (T <sub>J</sub> )	+150	°C
Operating Temp Range (T <sub>L</sub> )	-40 to +85	°C
Max Storage Temp	+150	°C

Operation of this device beyond any one of these limits may cause permanent damage. For reliable continuous operation, the device voltage and current must not exceed the maximum operating values specified in the table on page one. Bias Conditions should also satisfy the following expression:  $I_DV_D < (T_J - T_L) / R_{TH}, j - I$ 



#### Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

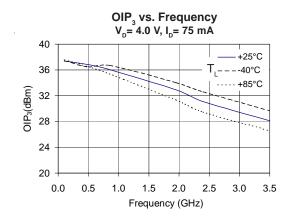
RoHS status based on EUDirective 2002/95/EC (at time of this document revision).

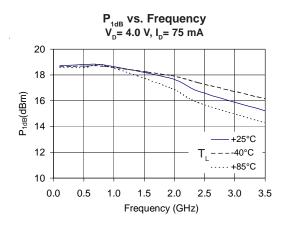
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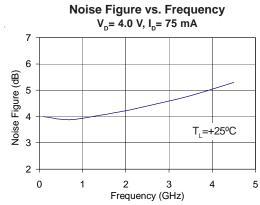
#### Typical Performance at Key Operating Frequencies

Parameter	Unit	100	500	850	1950	2400	3500
		MHz	MHz	MHz	MHz	MHz	MHz
Small Signal Gain	dB	14.0	13.9	13.6	12.4	11.2	9.6
Output Third Order Intercept Point	dBm	37.0	36.0	35.0	33.0	31.4	28.1
Output Power at 1dB Compression	dBm	18.7	19.0	18.7	17.8	16.8	15.2
Input Return Loss	dB	18.8	17.4	15.8	14.6	15.5	20.6
Output Return Loss	dB	35.7	36.3	23.8	13.9	13.4	16.4
Reverse Isolation	dB	18.4	18.6	18.8	18.8	18.5	17.0
Noise Figure	dB	4.0	3.9	3.9	4.2	4.4	4.8

Test Conditions:  $V_S = 8V$ ,  $I_D = 75 \text{ mA}$  Typ.,  $OIP_3$  Tone Spacing = 1MHz,  $P_{OLJT}$  per tone = 0 dBm,  $R_{BIAS} = 51\Omega$ ,  $T_L = 25 \,^{\circ}C$ ,  $Z_S = Z_L = 50\Omega$ 

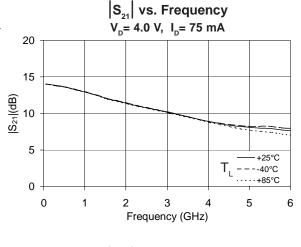


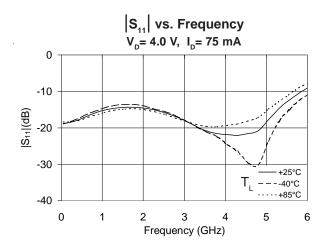


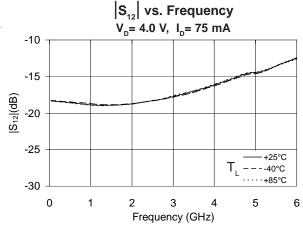


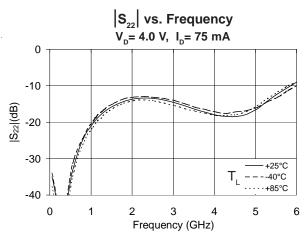


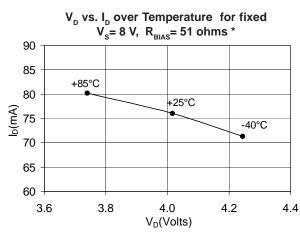


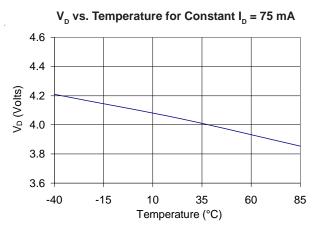










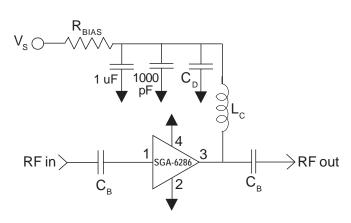


 $<sup>^{\</sup>star}$  Note: In the applications circuit on page 4, R $_{\scriptsize BIAS}$  compensates for voltage and current variation over temperature.



Pin	Function	Description
1	RF IN	RF input pin. This pin requires the use of an external DC-blocking capacitor chosen for the frequency of operation.
2, 4	GND	Connection to ground. For optimum RF performance, use via holes as close to ground leads as possible to reduce lead inductance.
3	RF OUT/BIAS	RF output and bias pin. DC voltage is present on this pin, therefor a DC-blocking capacitor is necessary for proper operation.

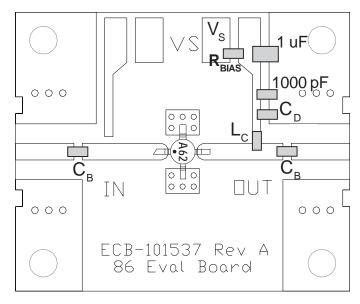
### **Application Schematic**



Reference	Frequency (Mhz)						
Designator	500	850	1950	2400	3500		
C <sub>B</sub>	220 pF	100 pF	68 pF	56 pF	39 pF		
C <sub>D</sub>	100 pF	68 pF	22 pF	22 pF	15 pF		
L <sub>c</sub>	68 nH	33 nH	22 nH	18 nH	15 nH		

Recommended Bias Resistor Values for $I_D = 75 \text{mA}$ $R_{BIAS} = (V_S - V_D) / I_D$					
Supply Voltage(V <sub>S</sub> )	6 V	8 V	10 V	12 V	
$R_{BIAS}$ 27 Ω 51 Ω 82 Ω 110 Ω					
Note: R <sub>bias</sub> provides DC bias stability over temperature.					

### **Evaluation Board Layout**

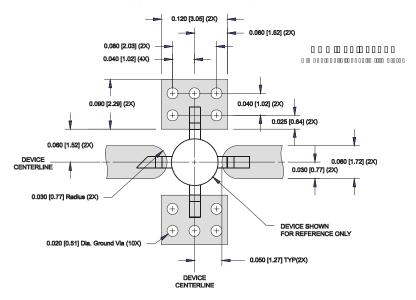


#### **Mounting Instructions**

- 1. Use a large ground pad area under device pins 2 and 4 with many plated through-holes as shown.
- 2. We recommend 1 or 2 ounce copper. Measurements for this data sheet were made on a 31 mil thick FR-4 board with 1 ounce copper on both sides.

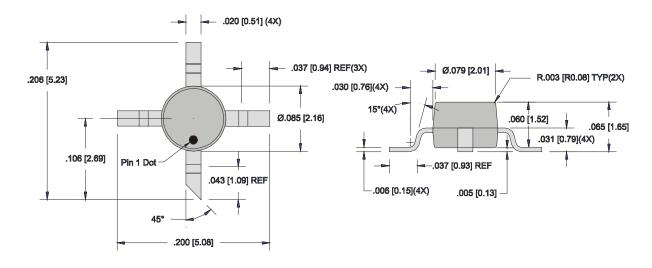


### **Suggested Pad Layout**



### **Package Drawing**

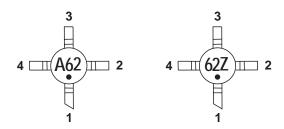
Dimensions in inches (millimeters)
Refer to drawing posted at www.rfmd.com for tolerances.



# **SGA-6286(Z)**



### **Part Identification**



## **Ordering Information**

Part Number	Reel Size	Devices/Reel
SGA-6286	13"	3000
SGA-6286Z	13"	3000